

Dow Silicone Sealants/Adhesives Technology Overview

Initial considerations for product selection

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DOW SILICONE TECHNOLOGY OVERVIEW

Sealing

Silicone reactive hotmelts

Adhesion promotion

Silane primers

Bonding

Pressure sensitive adhesives (PSA)

Coating application

Silicone coatings

Sealing & bonding

1-/2-part RTV sealants, room-temperature vulcanization

Sealing & bonding

1-/2-part HTV adhesives, high-temperature vulcanization



Encapsulation & protection

Silicone gels & potting materials

Gasketing

Cure-in-place gasket (CIPG), Dispensed foam gasket (DFG)

Rubber

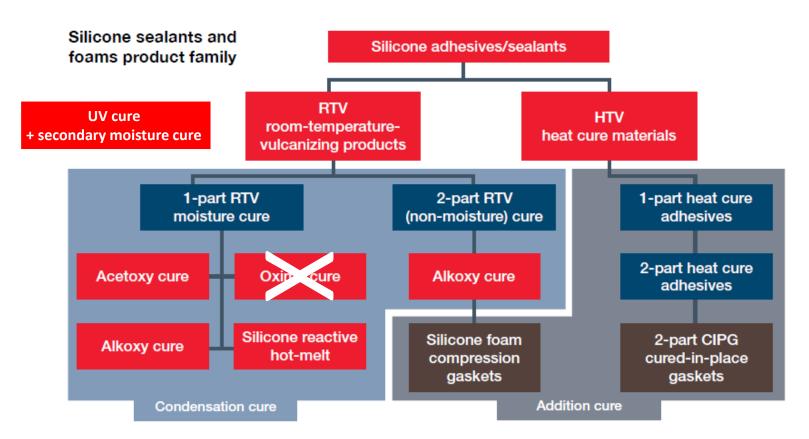
Mold-making rubber, High-consistency rubber (HCR), Liquid silicone rubber (LSR), 3D printing, EMI shielding

Thermal management

Thermally conductive (TC) and thermal interface materials (TIM)



DowsilTM Sealant/Adhesive & Gasket Technologies





RTV SEALANT & ADHESIVE PRODUCTS PORTFOLIO

- 1P RTV Acetoxy Sealants
- 1P RTV Alkoxy Sealants
- 2P RTV Alkoxy Adhesives
- 2P RTV Addition-Cure Adhesives
- DOWSIL™ Silicone Reactive Hotmelts

1P RTV ACETOXY SEALANTS

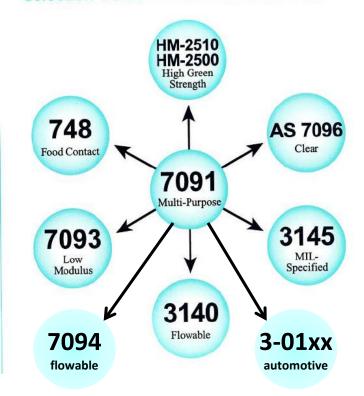
Selection Guide - Acetoxy Cure Products 732 MIL-Specified FDA, NSF, UL 732, 752 734, 736 Multi-Purpose High Food Contact Temperature AP Multi-Purpose 736 730 Q3-1566 Solvent Very High Resistant Temperature 734 Flowable

- + General industrial sealing & bonding applications
 - Silicone AP
- + FDA / NSF / MIL-Specified
 - 732
- + Very high temperature resistant
 - long-term 250°C, short term 275°C
 - Q3-1566
- + Flowable sealant
 - 734
- + Solvent resistant
 - 730 FS Sealant



1P RTV ALKOXY SEALANTS

Selection Guide - Neutral Cure Products



- + THE multi-purpose sealant
 - 7091
- + Low modulus sealant
 - 7093
- + **Self-leveling** sealant
 - 7094
- + Strong mechanical properties
 - **3145** non-flowing / **3140** flowable
- + Food contact (Complies with FDA 177.2600)
 - 748
- + Automotive fluid resistant
 - 3-01xx series
- + High green strength sealants
 - HM-25xx series



1P RTV ALKOXY SEALANTS

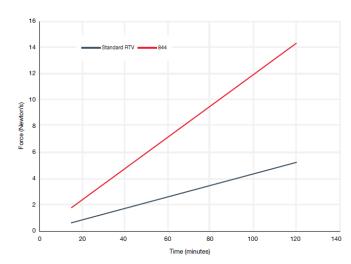
DOWSIL™ 844 RTV Adhesive Sealant

Considerations for product selection

- One-part, non-flowing moisture cure silicone adhesive
- Fast cure, fast tack free & high green strength
- High elongation for added stress relief
- Fast in-line processing with blowout resistance
- Durable adhesion to wide range of substrates
- Resistant to salt corrosion and UTH fluids

Lap Shear Adhesion Strength

DOWSIL™ 844 RTV Adhesive Sealant averages approximately 2-3x the green strength in early cure times of <8 hours



2P RTV ALKOXY ADHESIVES

Product		Hardness (Shore A)	Elongation at Break, %	Tensile Strength, MPa
Q3-3526	10-20	38	280	2.0
EA2626	10-20	45	200	2.2
Q3-3636	10-20	35	250	1.9

<u>2P System – Base + Catalyst</u>

Mix ratio 100:10 to 100:14 (w:w)

Q3-3526 Catalyst Grey

Q3-3526 Catalyst Black

Q3-3636 Catalyst Grey

Q3-3636 Catalyst Black

Q3-3636 Catalyst Special Black

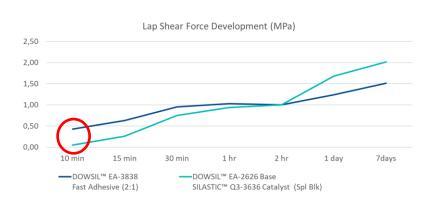
- + **Historical** product generation
 - Q3-3526
- + Faster curing 2P RTV
 - EA-2626
- + Fast curing + reduced volatile 2P RTV
 - EA-2727
- + Fast curing + low volatile 2P RTV
 - Q3-3636



2P RTV ALKOXY ADHESIVES

DOWSIL™ EA-3838 Fast Adhesive

- Very fast cure speed
- Adjustable cure speed due to variable 2:1 to 4:1 volumetric mix ratio
- Develops early primer-less adhesion on various substrates



		DOWSIL™ EA-3838 Fast Adhesive		
		2:1 Vol	3:1 Vol	4:1 Vol
Snap time - spatula (min:sec)		2:50	3:15	4:45
	Tack free time - PE foil (min:sec)	5:20	8:40	15:00
rce	10 min	0.56	0.17	0.03
	15 min	0.76	0.56	0.10
r fo	30 min	0.87*	0.90*	0.94
lop	1 hr	0.72	1.07	1.20*
Lap shear force development	2 hr	0.76	0.98	0.92
	1 day	1.06	1.19	1.49
	7 days	1.40	1.48	1.50

^{* 100%} Cohesive Failure on Stainless Steel Substrates

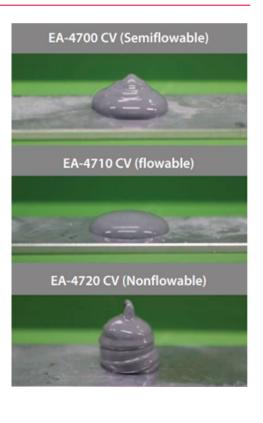


2P RTV ADDITION-CURE ADHESIVES

DOWSIL™ EA-4700 CV / EA-4710 CV / EA-4720 CV Adhesive

- Addition-Cure chemistry
- Mix ratio 1:1
- Cure time* at 25°C -> 2 / 4 / 6 hours
- Cure rate is rapidly accelerated with heat
- Controlled Volatility (D4-D10) -> 130** / 30*** / 80*** ppm

Adherend	Unit	EA-4700 CV	EA-4710 CV	EA-4720 CV
Aluminum A5052P		3.1	3.0	3.5
Die casted aluminum (ADC-12)		2.5	1.5	2.7
Polybutylene terephthalate (PBT)		2.1	2.0	1.1
Polyphenylene sulfide		2.4	2.4	2.4
Copper	MPa	2.4	1.1	0.6
SUS304		2.6	1.3	2.6
Phenol resin		2.2	2.1	2.5
Glass epoxy (FR-4)		2.4	2.3	2.9
Polyethylene terephthalate		2.6	2.1	2.6
Nylon 66		2.1	1.9	2.4
Polycarbonate		1.9	2.6	2.8
Glass		2.9	2.9	3.0



^{*} hardness completion; adhesion not completed

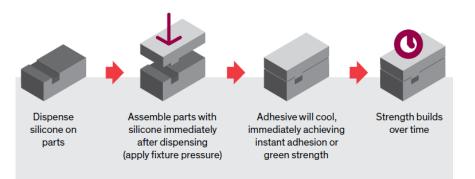
^{**} Hexane extraction 24 hours

^{***} CTM0625B

DOWSIL™ SILICONE REACTIVE HOTMELTS

Considerations for product selection

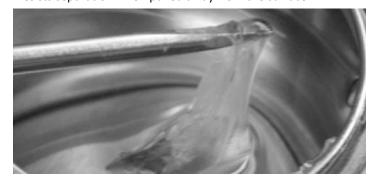
- 1P RTV Alkoxy cure silicone sealant
- Instant adhesion for immediate handling of components
- Primer-less adhesion to most plastics and metals
- Very high elongation > 1000%





Before cure: Product is gummy, separates easily and remains on the tool when pulled away from the surface.

After cure: Product displays rubbery features, stretches and resists separation when pulled away from the surface.



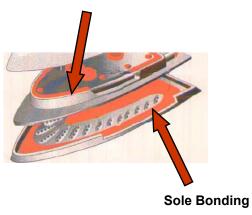
HTV SEALANT, ADHESIVE & GASKETING PRODUCTS PORTFOLIO

- 1P HTV Adhesives
- 2P HTV Adhesives
- Silicone Foam and CIPG products for gasketing applications

1P HTV ADHESIVES

- + Historical product generation
 - XIAMETER™ ADH-6045 Adhesive
- + General industry applications + High temperature resistance
 - XIAMETER™ ADH-6066 Adhesive flowable
 - DOWSIL™ 3-6096 Adhesive non-flowing
 - Typical cure temperature 150°C
- + Typical applications
 - **Steam Iron** sole bonding
 - Bonding of domestic **oven doors**
 - Assembling of ceramic cooking hobs





1P HTV ADHESIVES

2P HTV ADHESIVES

DOWSIL™ FA-6060 Adhesive

DOWSIL™ EA-7300 Adhesive

Considerations for product selection

- 1P non-flowing, low-temperature heat-cure adhesive
- **Dual cure** -> rapid thermal radical cure + moisture cure
 - Cure time (to > 90% final adhesion) 30 minutes at 105°C
 - Cure time (to > 90% final adhesion) 5 minutes at 125°C
- Excellent resistance to salt spray & thermal cycling

Considerations for product selection

- Low-temperature cure
 - 10 minutes at 100°C
 - 30 minutes at 80°C
- Durable adhesion to typical automotive substrates (i.e., PBT 30GF, PA 66, steel, aluminum)
- Use of a scavenger to reduce voids during cure
- UV dye for inspection

DOWSIL™ EA-7300 adhesive also has a **secondary moisture cure** which will occur over the course of several days following heat cure. During this secondary moisture cure, **physical properties and adhesion will continue to build for approximately 3-7 days**, depending on atmospheric conditions. **Parts can be moved and handled following the initial heat cure** and properties will continue to build during storage or shipping.

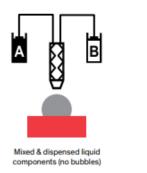


SILICONE FOAM AND CIPG PRODUCTS FOR GASKETING APPLICATIONS

DOWSIL™ 3-82xx / EF-65xx

Considerations for product selection

- 2P RTV Silicone foam
- Foam develops by **H2** generation from cure reaction
- Typical foaming time is 10 20 min
- Low modulus Silicone foam gaskets
- Product range density from 150 450 kg/m³





Expanded & cured solid (elastomer with bubbles)

SILASTIC™ RBL-9694-30P / RBL-9694-45M

- 2P HTV Silicone Rubber
- Typical cure time 10 min at 150°C
- Medium modulus Silicone **rubbe**r gaskets

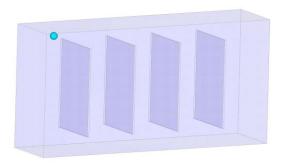




SIMULATIONS WITH FOAM AND CIPG PRODUCTS

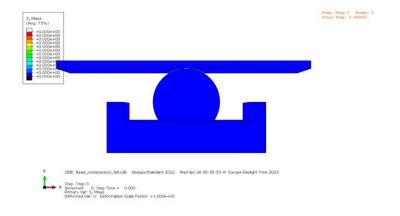
DOWSIL™ EF-6559

Foam filling simulation



SILASTIC™ RBL-9694-45M

Compression gasket simulation



UV CURE + SECONDARY MOISTURE CURE PRODUCTS PORTFOLIO

■ 1P UV cure with secondary moisture cure Sealants

1P UV CURE WITH SECONDARY MOISTURE CURE SEALANTS

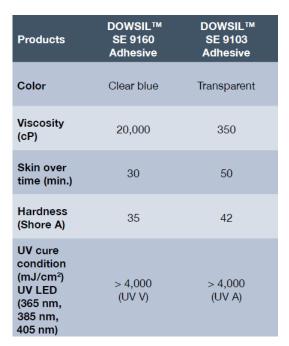
DOWSIL™ SE 91XX Dual Cure Silicone Adhesives

Features & benefits

- UV + RTV dual cure system
- Instant material cure with UV irradiation for fast in-line processing
- Shadow area cure with fast secondary moisture cure
- Excellent repairability after cure for cost saving from targeted substrates
- Excellent flowing and filling in small holes and gaps in applications

Dispensing	UV exposure	Room temperature cure for shadow area
	Instant cure by UV irradiation Shadow area	Fast secondary moisture-cure in deep gaps and holes

Solutions for faster assembly, low production cost and reliable performance





Seek

TogetherTM

DISCLAIMER

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